

# STTH8R06-Y

## Automotive Turbo 2 ultrafast high voltage rectifier

### Features

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses
- AEC-Q101 qualified

### Description

The STTH8R06, which uses ST Turbo 2 600 V technology, is specially suited as a boost diode in continuous mode power factor correction and hard switching conditions. This device is also intended for use as a free wheeling diode in power supplies and other power switching applications.

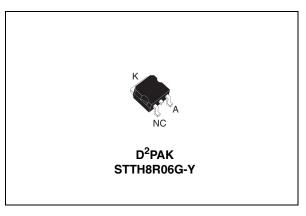


Table 1.Device summary

Symbol	Value
I <sub>F(AV)</sub>	8 A
V <sub>RRM</sub>	600 V
Tj	175 °C
V <sub>F</sub> (typ)	1.5 V
t <sub>rr</sub> (max)	45 ns

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## 1 Characteristics

#### Table 2. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage	600	V	
I <sub>F(RMS)</sub>	Forward rms current	40	А	
I <sub>F(AV)</sub>	Average forward current $\delta = 0.5$ $T_c = 135 \ ^{\circ}C$		8	А
I <sub>FSM</sub>	Surge non repetitive forward current	90	А	
T <sub>stg</sub>	Storage temperature range	-65 to + 175	°C	
Тj	Operating junction temperature range	-40 to + 175	°C	

#### Table 3.Thermal resistance

Symbol	Parameter	Value (max)	Unit
R <sub>th(j-c)</sub>	Junction to case	1.9	°C/W

### Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	Povoroo lookago ourront	T <sub>j</sub> = 25 °C	V _ V			30	
'R	I <sub>R</sub> Reverse leakage current	T <sub>j</sub> = 125 °C	V <sub>R</sub> = V <sub>RRM</sub>		35	400	μA
V	V <sub>F</sub> Forward voltage drop	T <sub>j</sub> = 25 °C	L _ Q A			3.2	V
۷F		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 8 A		1.5	1.95	v

To evaluate the conduction losses use the following equation:

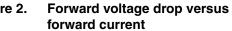
 $P = 1.35 \text{ x } I_{F(AV)} + 0.075 I_{F}^{2}(\text{RMS})$ 



Table 5. **Dynamic characteristics** 

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit	
		I <sub>F</sub> = 0.5 A, I <sub>rr</sub> = 0.25 A, I <sub>R</sub> =1 A			25			
t <sub>rr</sub> Reverse recovery time		T <sub>j</sub> = 25 °C	$I_F = 1 \text{ A},$ $dI_F/dt = -50 \text{ A}/\mu\text{s},$ $V_R = 30 \text{ V}$			45	ns	
I <sub>RM</sub>	Reverse recovery current				5.5	7.2	А	
S factor	Softness factor	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 8 A, V <sub>R</sub> = 400 V, dI <sub>F</sub> /dt = -200 A/μs		0.4			
Qrr	Reverse recovery charges				150		nC	
t <sub>fr</sub>	Forward recovery time	$T_{j} = 25 \ ^{\circ}C \qquad \begin{array}{l} I_{F} = 8 \ \text{A}, \\ dI_{F}/dt = 64 \ \text{A}/\mu s \\ V_{FR} = 2.5 \ \text{V} \end{array}$				200	ns	
V <sub>FP</sub>	Forward recovery voltage					5	V	

Figure 1. Average forward power dissipation Figure 2. versus average forward current



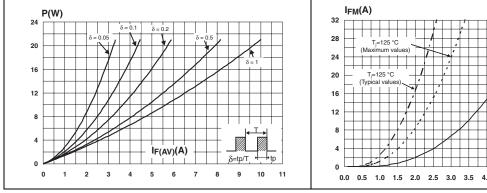


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

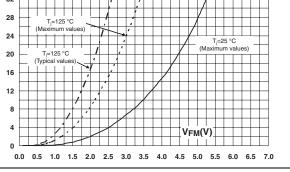
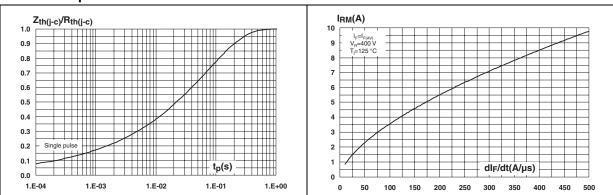
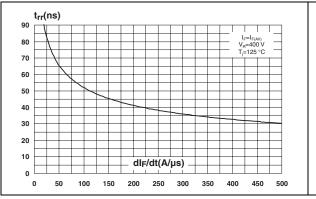
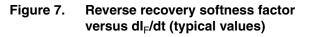


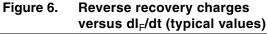
Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)

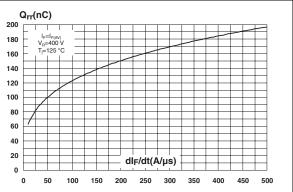


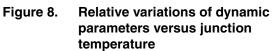
# Figure 5. Reverse recovery time versus dl<sub>F</sub>/dt (typical values)

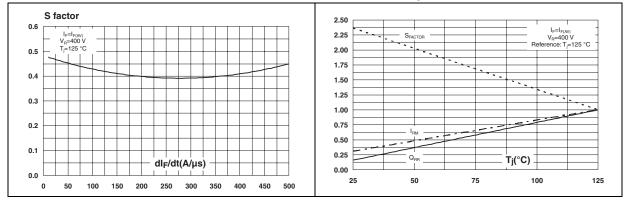






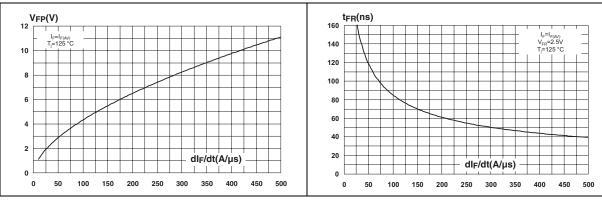








## Figure 9. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values)



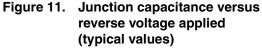
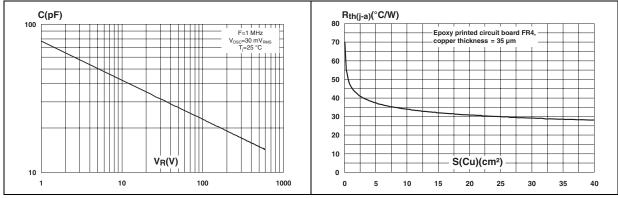


Figure 12. Thermal resistance junction to ambient versus copper surface under tab

Figure 10. Forward recovery time versus

dl<sub>F</sub>/dt (typical values)





## 2 Package information

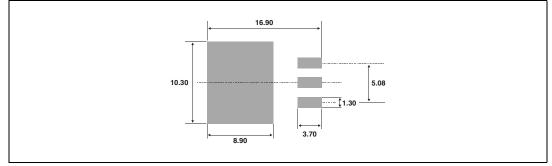
- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6.D<sup>2</sup>PAK dimensions

			Dimer	nsions	
	Ref.	Millimeters		Inches	
		Min.	Max.	Min.	Max.
	A	4.40	4.60	0.173	0.181
	→ A1	2.49	2.69	0.098	0.106
	- A2	0.03	0.23	0.001	0.009
	В	0.70	0.93	0.027	0.037
	с В2	1.14	1.70	0.045	0.067
		0.45	0.60	0.017	0.024
	C2	1.23	1.36	0.048	0.054
$\begin{array}{c} \rightarrow & B^2 \\ \rightarrow & B \end{array}  C  C  C$	R D	8.95	9.35	0.352	0.368
G	E	10.00	10.40	0.393	0.409
<u>A2</u>	G	4.88	5.28	0.192	0.208
	L	15.00	15.85	0.590	0.624
M ↓ ↓	v2 L2	1.27	1.40	0.050	0.055
* FLAT ZONE NO LES	S THAN 2mi	1.40	1.75	0.055	0.069
	М	2.40	3.20	0.094	0.126
	R	0.40	typ.	0.01	6 typ.
	V2	0°	8°	0°	8°





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## **3** Ordering information

### Table 7. Ordering information

Order code	Marking	arking Package We		Base qty	Delivery mode
STTH8R06GY-TR	STTH8R06GY	D <sup>2</sup> PAK	1.48 g	1000	Tape and reel

## 4 Revision history

### Table 8.Document revision history

Date	Revision	Changes
03-Nov-2011	1	Initial release.



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